



Shenzhen Tuofeng Semiconductor Technology Co., Ltd

**N - CHANNEL ENHANCEMENT MODE POWER MOSFET****TF50N06****• General Description**

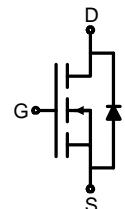
The TF50N06 combines advanced trench MOSFET technology with a low resistance package to provide extremely low  $R_{DS(ON)}$ . This device is ideal for load switch and battery protection applications.

**• Features**

- Advance high cell density Trench technology
- Low  $R_{DS(ON)}$  to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance

**• Application**

- MB/VGA Vcore
- SMPS 2<sup>nd</sup> Synchronous Rectifier
- POL application
- BLDC Motor driver

**• Product Summary**

$V_{DS} = 60V$     $I_D = 50A$   
 $R_{DS(on)(10V\ typ)} = 14m\Omega$   
 $R_{DS(on)(4.5V\ typ)} = 18m\Omega$



TO-251



TO-252

**• Ordering Information:**

Part NO.	TF50N06
Marking1	TF:tuofeng; 50N06:TF50N06
Marking2	Y:year code; XX:Week; AA:device code;
Basic ordering unit (pcs)	2500

**• Absolute Maximum Ratings ( $T_C = 25^\circ C$ )**

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	$V_{DS}$	60	V
Gate-Source Voltage	$V_{GS}$	20	V
Continuous Drain Current	$I_D@TC=25^\circ C$	50	A
	$I_D@TC=75^\circ C$	35	A
	$I_D@TC=100^\circ C$	30	A
Pulsed Drain Current <sup>①</sup>	$I_{DM}$	104	A
Total Power Dissipation( $TC=25^\circ C$ )	$P_D@TC=25^\circ C$	70	W
Total Power Dissipation( $TA=25^\circ C$ )	$P_D@TA=25^\circ C$	2.8	W
Operating Junction Temperature	$T_J$	-55 to 150	$^\circ C$
Storage Temperature	$T_{STG}$	-55 to 150	$^\circ C$
Avalanche Current	$I_{AS} I_{AR}$	40	A



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**N - CHANNEL ENHANCEMENT MODE POWER MOSFET****TF50N06****•Thermal resistance**

Parameter	Symbol	Min.	Typ.	Max.	Unit
Thermal resistance, junction - case	R <sub>thJC</sub>	-	-	2.8	° C/W
Thermal resistance, junction - ambient	R <sub>thJA</sub>	-	-	55	° C/W
Soldering temperature, wavesoldering for 10s	T <sub>sold</sub>	-	-	265	° C

**•Electronic Characteristics**

Parameter	Symbol	Condition	Min.	Typ	Max.	Unit
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250uA	60			V
Gate Threshold Voltage	V <sub>GS(TH)</sub>	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA	1.0	1.5	2.2	V
Drain-Source Leakage Current	I <sub>DSS</sub>	V <sub>DS</sub> =60V, V <sub>GS</sub> =0V			1.0	uA
Gate- Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V			±100	nA
Static Drain-source On Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =20A		14	21	mΩ
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =15A		18	25	mΩ
Forward Transconductance	g <sub>FS</sub>	V <sub>DS</sub> =25V, I <sub>D</sub> =10A		20		S
Source-drain voltage	V <sub>SD</sub>	I <sub>S</sub> =20A			1.20	V

**•Electronic Characteristics**

Parameter	Symbol	Condition	Min.	Typ	Max.	Unit
Input capacitance	C <sub>iss</sub>	V <sub>DS</sub> =25V V <sub>GS</sub> = 0V f = 1MHz	-	1000	-	pF
Output capacitance	C <sub>oss</sub>		-	108.5	-	
Reverse transfer capacitance	C <sub>rss</sub>		-	96.9	-	

**•Gate Charge characteristics(Ta= 25°C)**

Parameter	Symbol	Condition	Min.	Typ	Max.	Unit
Total gate charge	Q <sub>g</sub>	V <sub>DD</sub> =25V I <sub>D</sub> = 10A V <sub>GS</sub> = 10V	-	15	-	nC
Gate - Source charge	Q <sub>gs</sub>		-	4.5	-	
Gate - Drain charge	Q <sub>gd</sub>		-	7.5	-	

Note: ① Pulse Test : Pulse width ≤ 300μs, Duty cycle ≤ 2% ;



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## N - CHANNEL ENHANCEMENT MODE POWER MOSFET

**TF50N06**

Fig.1 Power Dissipation

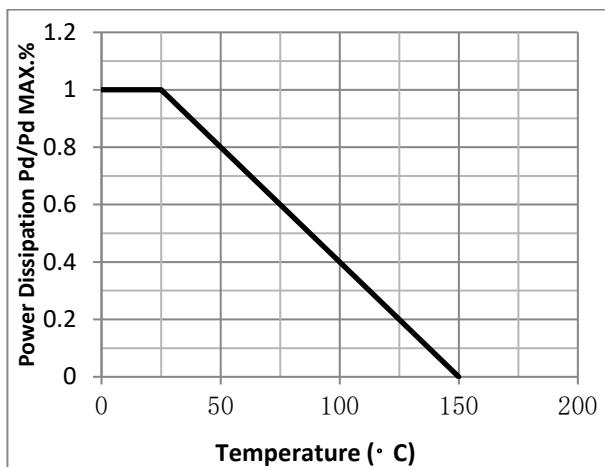


Fig.2 Typical output Characteristics

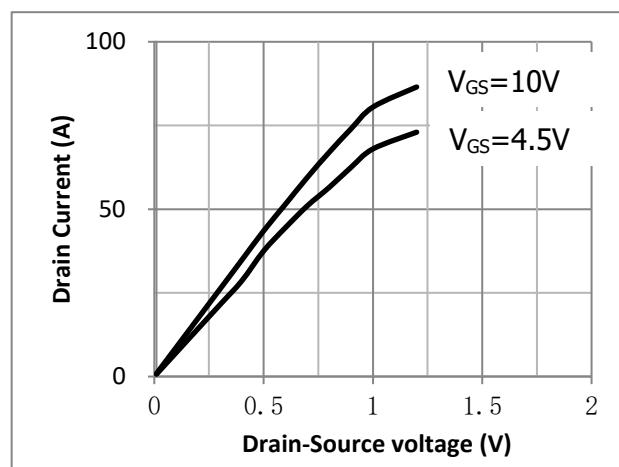


Fig.3 Threshold Voltage V.S Junction Temperature

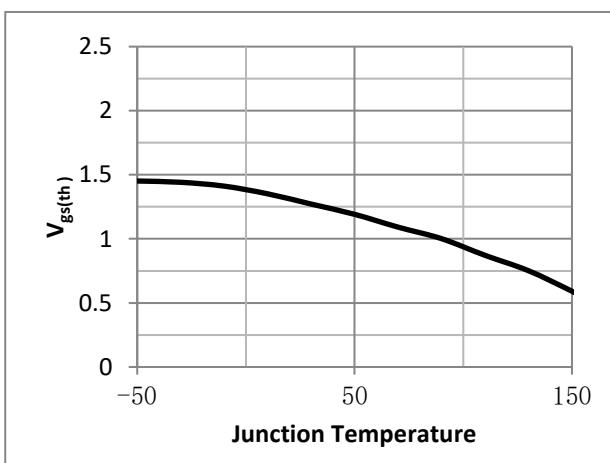


Fig.4 Resistance V.S Drain Current

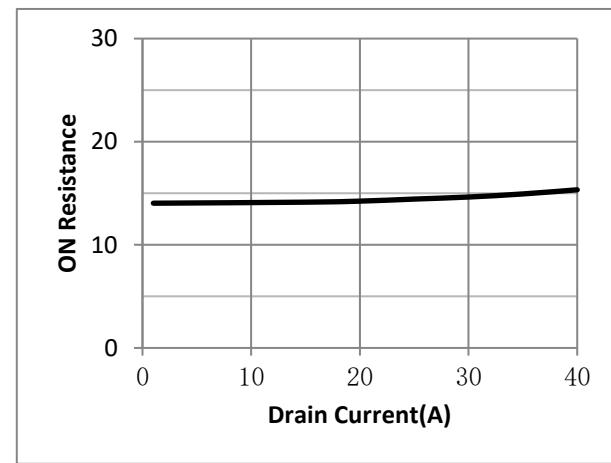


Fig.5 On-Resistance VS Gate Source Voltage

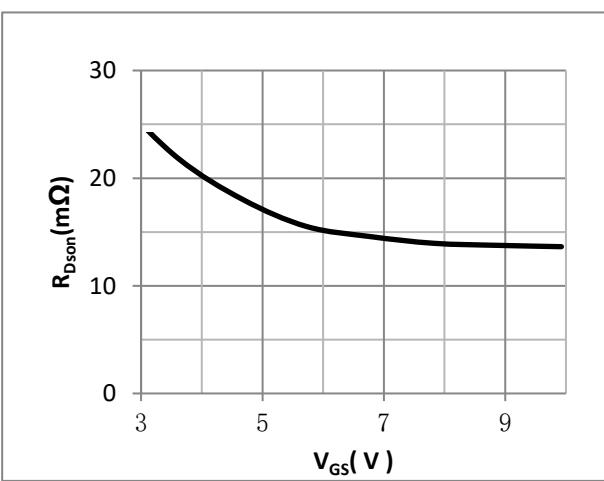


Fig.6 On-Resistance V.S Junction Temperature

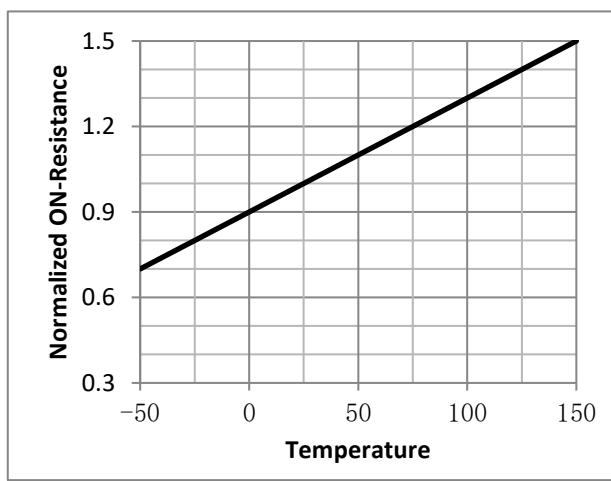


Fig.7 Switching Time Measurement Circuit

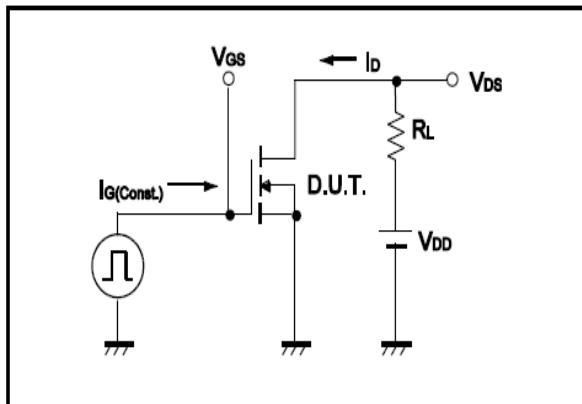


Fig.8 Gate Charge Waveform

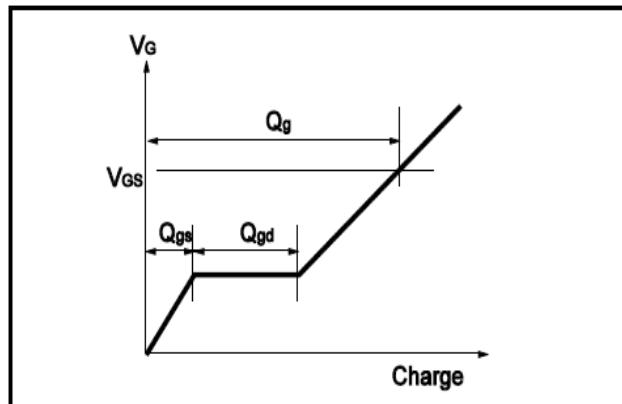


Fig.9 Switching Time Measurement Circuit

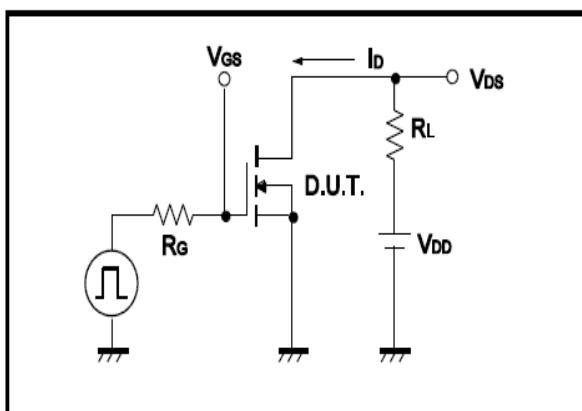


Fig.10 Gate Charge Waveform

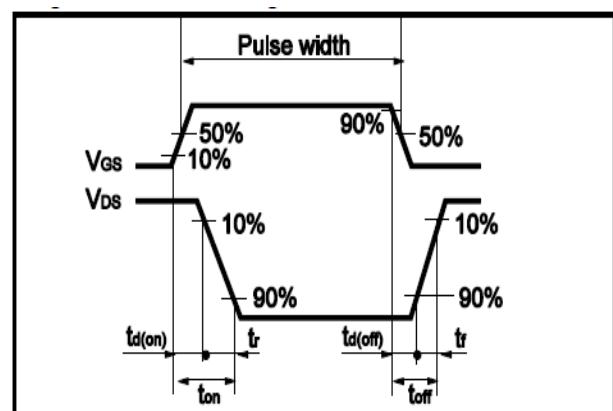


Fig.11 Avalanche Measurement Circuit

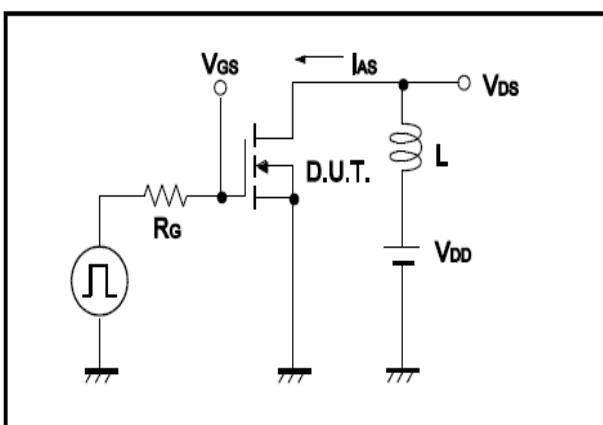
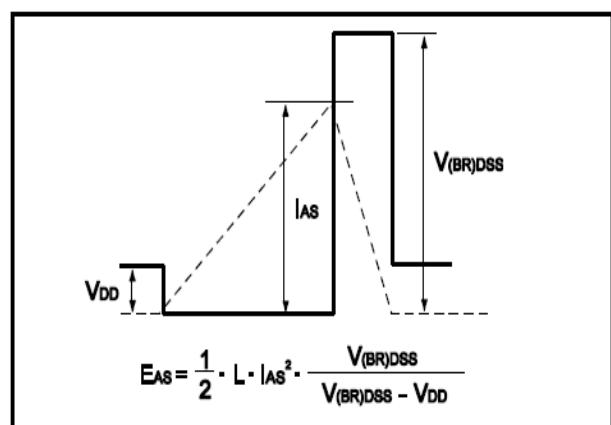


Fig.12 Avalanche Waveform





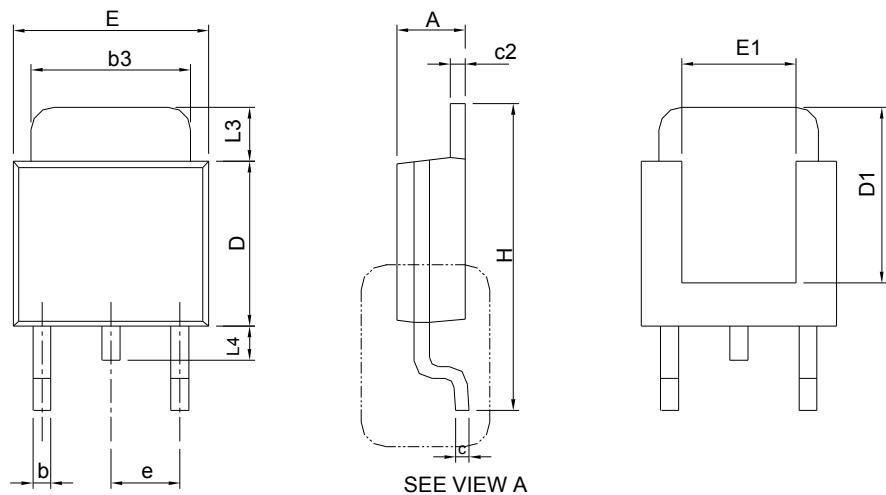
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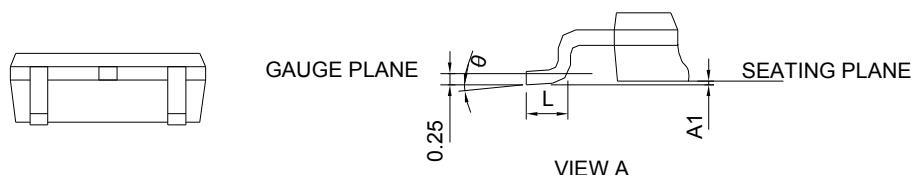
**TF50N06**

## Package Information

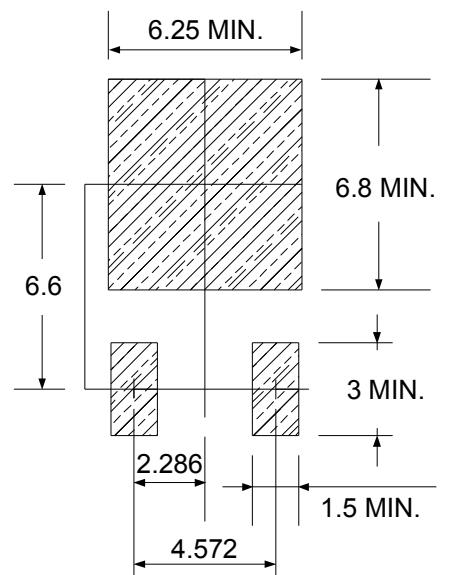
TO-252



SEE VIEW A



### RECOMMENDED LAND PATTERN



UNIT: mm

SYMBOL	TO-252			
	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A	2.18	2.39	0.086	0.094
A1		0.13		0.005
b	0.50	0.89	0.020	0.035
b3	4.95	5.46	0.195	0.215
c	0.46	0.61	0.018	0.024
c2	0.46	0.89	0.018	0.035
D	5.33	6.22	0.210	0.245
D1	4.57	6.00	0.180	0.236
E	6.35	6.73	0.250	0.265
E1	3.81	6.00	0.150	0.236
e	2.29 BSC		0.090 BSC	
H	9.40	10.41	0.370	0.410
L	0.90	1.78	0.035	0.070
L3	0.89	2.03	0.035	0.080
L4		1.02		0.040
θ	0°	8°	0°	8°